



SGU | SEMI Global Update

January 28, 2020



December 2019 Billings Surge



Summit Opens! Advanced Packaging in Focus



Forum Insights: Talent, China, Data for Social Good



METIS Consortium Kickoff Meeting: Key Takeaways



Art of the Impossible: Invisible Mobile Devices



New SEMI S2 Pressure Guidelines Task Force



SEMI-Related: PigeonBot and Future of Flight

More News...

[Window on China](#)

[SEMI Blogs](#)

[Advanced Packaging](#)

Upcoming Events

Jan 27-29	3D & Systems Summit	Dresden, Germany
Feb 5-7	SEMICON Korea 2020	Seoul, Korea
Feb 24-27	FLEX/MSTC 2020	San Jose, California

[Click here for all events.](#)



Don't miss your last chance to submit a nomination for the 2020 3D InCites Awards.

We'd love your input. Please send feedback about this newsletter to Michael Hall at semiglobalupdate@semi.org.

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